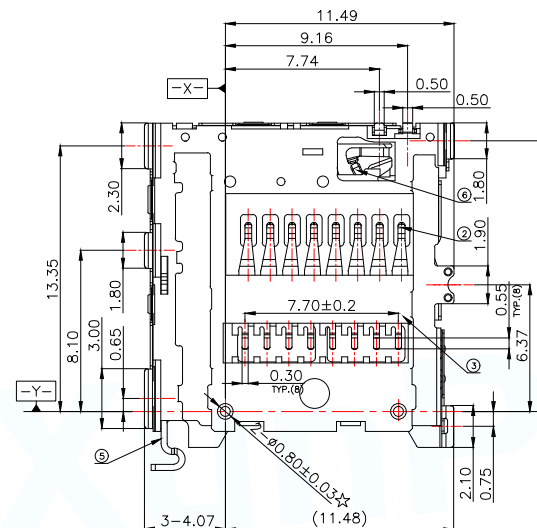
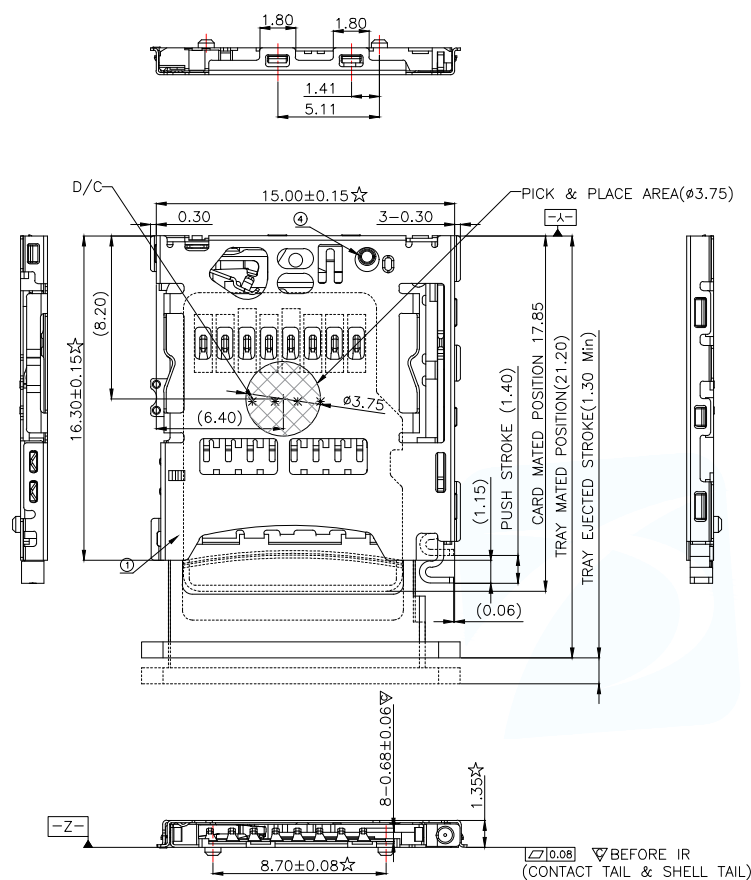




NOTES:

1. MATERIAL:

1.1 SEE THE ATTACHED TABLE

1.2 PLATING SPEC. AS BELOW:

2. SPECIFICATION:

2.1 ELECTRICAL CHARACTERISTICS:

a CURRENT RATING: 0.5A MAX./PIN

b DIELECTRIC WITHSTANDING VOLTAGE: 500V AC FOR 1 MINUTE

c CONTACT RESISTANCE: 50 mOhm MAX.

d INSULATION RESISTANCE: 1000 Megohms MIN.

2.2 MECHANICAL CHARACTERISTICS:

a DURABILITY: 2000 CYCLES

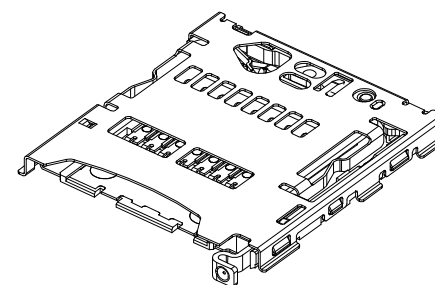
b TRAY MATING FORCE: 15N MAX.; TRAY UNMATING FORCE:

3N MIN.

3. RECOMMENDED PROCESS DONDION: IR-REFLOW, PEAK TEMPERATURE AND TIME: 250°C, 5~10S. BEFORE IR-REFLOW THE CO-PLANARITY 0.08MM MAX; AFTER 2 TIMES IR-REFLOW THE CO-PLANARITY 0.10MM MAX

4. DIMENSIONS MARKED ★ SHOULD BE CHECKED BY Q.C. AND PROCESS ENGINEERS,AND DIMENSIONS MARKED ▽ SHOULD CHECK THE CPK DATE

5. DATE CODE TO BE PRINTED ON THIS AREA

LINE
DAY
MONTH
YEAR

6	SWITCH	1	COPPER ALLOY	Contact Area: 15u" Au & Solder Area: 1u" Au	
5	LEVER	1	STAINLESS STEEL	CLEANING	
4	CAM	1	STAINLESS STEEL	CLEANING	
3	I/M HSG	1	THERMOPLASTIC	BLACK COLOR, UL94-V0	
2	CONTACT	1	COPPER ALLOY	Contact Area: 15u" Au & Solder Area: 1u" Au	
1	SHELL	1	STAINLESS STEEL	Solder Area: 1u" Au	
ITEM	PART NAME	Q'TY	MATERIAL	FINISHING	REMARK

MANUFACTURE DWG

东莞市讯普电子科技有限公司
DongGuan XunPu Electronics Co.,LtdUNLESS OTHERWISE
SPECIFIED TOLERANCESTITLE:1.35H PIN PUSH T-Flash
CARD CONN.(With Tray)

PAR

TF-107

DECIMALS:

ANGLES:

X.:±0.50

X':±2°

X.X:±0.20

X.X':±1°

X.XX:±0.10

X.XX':±0.5°

DWN

CHKD

APVD

SCALE:1:1

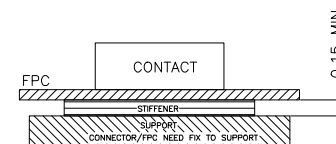
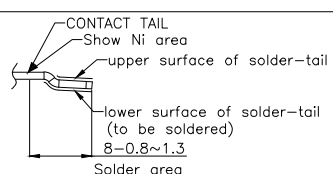
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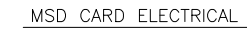
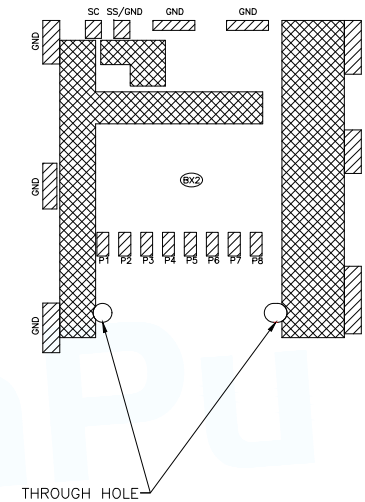
SIZE:A4

SHEET:1F4

REV:A

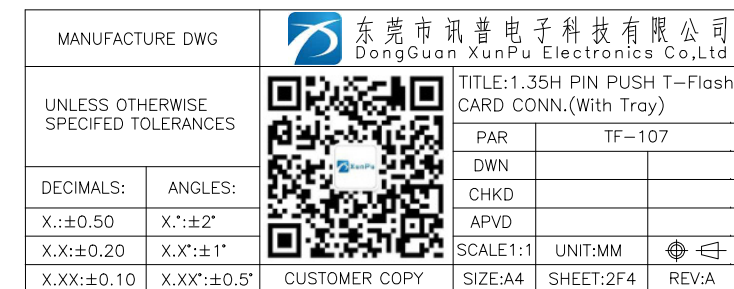
CUSTOMER COPY

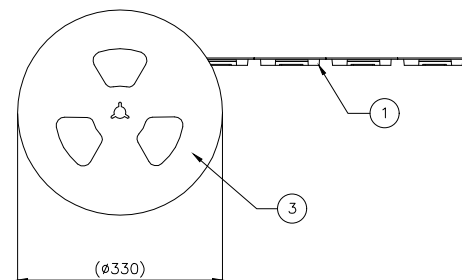
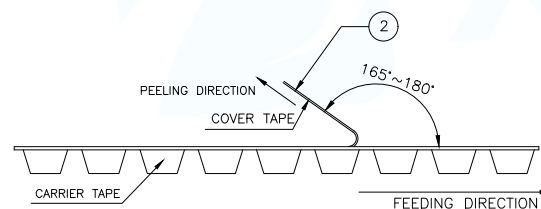




ITEM	FUNCTION
	MICRO SD CARD
P1	DAT1 OF MSD
P2	DAT0 OF MSD
P3	VSS OF MSD
P4	CLK OF MSD
P5	VDD OF MSD
P6	CMD OF MSD
P7	CD/DAT3 OF MSD
P8	DAT2 OF MSD
SC	SW CONTACT
SS	SW SPRING

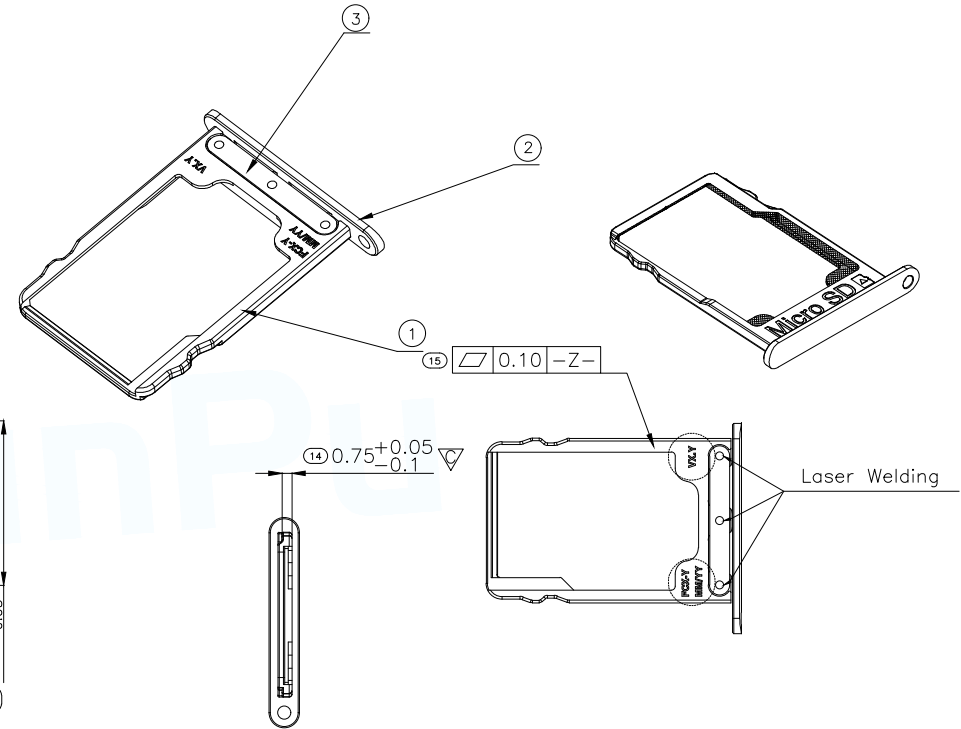
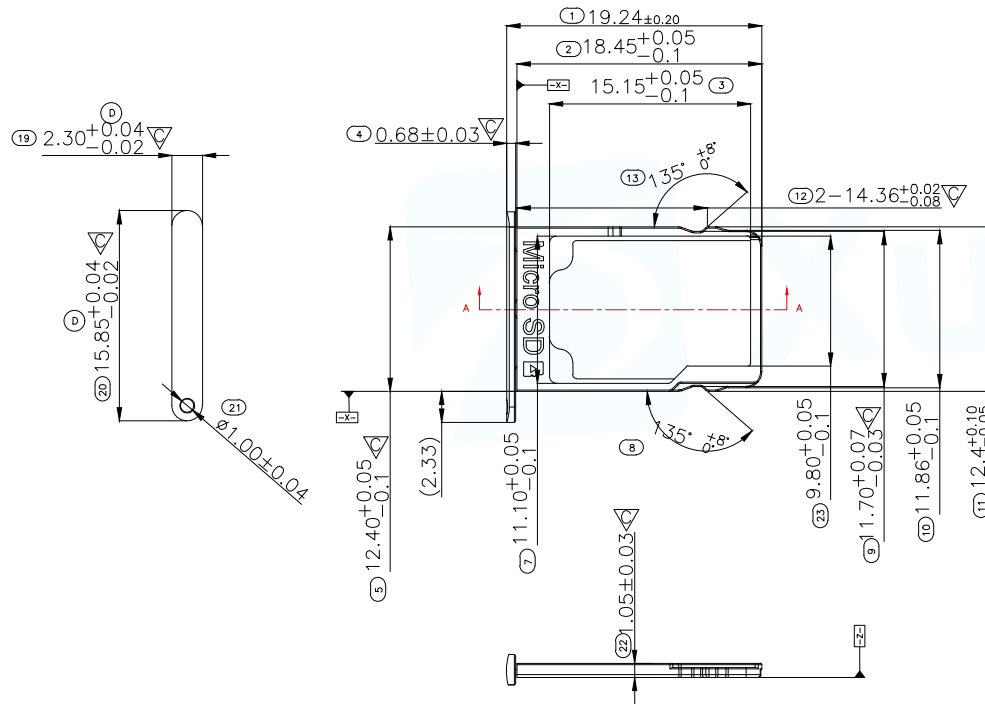
 SOLDER AREA
 NO PATTERNS





- | | | | | | | | |
|---------------------------------------|--------------|------------|---|--|---|---|--------|
| 3 | REEL | 1 | 1 | PLYOSTYRENE | / | | |
| 2 | COVER TAPE | 1 | 1 | PLYOSTYRENE | CRYSTAL | | |
| 1 | CARRIER TAPE | 1 | 1 | THERMOPLASTIC | CRYSTAL | | |
| ITEM | PART NAME | Q'TY | | MATERIAL | FINISHING | | REMARK |
| MANUFACTURE DWG | | | |  东莞市讯普电子科技有限公司
DongGuan XunPu Electronics Co.,Ltd | | | |
| UNLESS OTHERWISE SPECIFIED TOLERANCES | | | |  | TITLE: 1.35H PIN PUSH T-Flash CARD CONN.(With Tray) | | |
| | | | | | PAR | TF-107 | |
| DECIMALS: | | ANGLES: | | | DWN | | |
| X.:±0.50 | | X.:±2° | | | CHKD | | |
| X.X:±0.20 | | X.X:±1° | | | APVD | | |
| X.XX:±0.10 | | X.XX:±0.5° | | SCALE:1:1 | UNIT:MM |  | |
| CUSTOMER COPY | | | | SIZE:A4 | SHEET:3F4 | REV:A | |

REMARK	
FCX-Y	Tool identify number
X	
Y	
VX.Y	Version identify number
X	Part revision: 1~Z
Y	Tool revision: 1~Z
MM/YY	Date identify number
MM	Months: 01~12
YY	Year: 17,18,19,...



NOTES:

1. Material: SEE THE ATTACHED TABLE

2. 外观处理: 需遵照ID工艺文件.

2.1 Add insulating oil in card slot, color: white

2.2 产品表面不得有锋利边, 毛刺, 压痕, 划伤, 刀纹, 油污, 多料, 缺料, 台阶, 扭曲变形, 裂痕等缺陷.

3. 尺寸: 2D图面未标注公差尺寸, 其公差参照公差表; 未标注尺寸, 参照3D图档, 其公差参照公差表;

带 ☆ 尺寸为重点尺寸, 要求每批次检验; 带 ▽ 尺寸需管控CPK;

未注工艺圆角, R ≤ 0.1mm; 未注同轴度0.1mm, 未注垂直度0.1mm;

尺寸序号: 1~23.

4. 产品需满足(EU)WEEE和ROHS等认证要求.

3	PLATE	SUS304	CLEANING
2	CNC TRAY DOOR	AL6063	ANODIZE, SANDBLASTING
1	MIM TRAY	17-4PH F	COLOR: SILVER
ITEM	PART NAME	MATERIAL	FINISHED
MANUFACTURE DWG		东莞市讯普电子科技有限公司 DongGuan XunPu Electronics Co.,Ltd	
UNLESS OTHERWISE SPECIFIED TOLERANCES		TITLE:1.35H PIN PUSH T-Flash CARD CONN.(With Tray)	
DECIMALS:		PAR	
X.:±0.50		TF-107-KT	
X.X:±0.20		DWN	
X.XX:±0.10		CHKD	
ANGLES:		APVD	
X.X':±2°		SCALE1:1	
X.X':±1°		UNIT:MM	
X.XX':±0.5°		SIZE:A4	
CUSTOMER COPY		SHEET:4F4	
		REV:A	